

KEMET Part Number: C1825C104JBGACTU
(C1825C104JBGAC7800)

SMD Comm C0G HV, Ceramic, 0.1 uF, 5%, 630 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1825



Dimensions

Chip Size	1825
L	4.5mm +/-0.3mm
W	6.4mm +/-0.4mm
T	2.5mm +/-0.20mm
B	0.6mm +/-0.35mm

Packaging Specifications

Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	500

General Information

Series:	SMD Comm C0G HV
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features:	Ultra-Stable, Low Loss, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	0.1 uF
Capacitance Tolerance:	5%
Voltage DC:	630 VDC
Dielectric Withstanding Voltage:	819 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	C0G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.10% 1kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms